



MX553BHA156M250

Ultra-Low Jitter 156.25MHz LVPECL XO

ClockWorks® FUSION

General Description

The MX553BHA156M250 is an ultra-low phase jitter XO with LVPECL output optimized for high line rate applications.

Applications

- 10/40/400 Gigabit Ethernet
- Fibre Channel 10G/12G SERDES

Absolute Maximum Ratings¹

| | |
|--|-----------------|
| Supply Voltage (VIN)..... | +4.6V |
| Lead Temperature (soldering, 10s)..... | 260°C |
| Case Temperature..... | 115°C |
| Storage Temperature (T _g)..... | -65°C to +125°C |
| ESD Machine Model..... | 200V |
| ESD Rating (HBM)..... | 2kV |

Electrical Characteristics

VDD = 2.375 - 3.63V, TA = -10°C to +75°C, outputs terminated with 50Ω to VDD - 2V.³

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|--------|-----------------------------------|---|------------|------------|-----------|-------|
| IDD | Supply Current | | | | 120 | mA |
| F0 | Center Frequency | | | 156.25 | | MHz |
| | Frequency Stability | Note 4 | | | ±20 | ppm |
| ∅j | Phase Noise | Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz) | | 154 104 | | fsRMS |
| Tstart | Start-Up Time | | | | 20 | ms |
| TR/TF | Rise/Fall time | | 85 | | 350 | ps |
| | Duty Cycle | | 45 | | 55 | % |
| VOH | Output High Voltage | LVPECL output levels | VDD - 1.35 | VDD - 1.01 | VDD - 0.8 | V |
| VOL | Output Low Voltage | LVPECL output levels | VDD - 2.0 | VDD - 1.78 | VDD - 1.6 | V |
| Vswing | Peak to Peak Output Voltage Swing | | 0.65 | 0.77 | 0.95 | V |

Notes:

1. Exceeding the absolute maximum ratings may damage the device.
2. The device is not guaranteed to function outside its operating ratings.
3. Guaranteed after thermal equilibrium.
4. Inclusive of initial accuracy, supply voltage, temperature drift, aging (5yrs), shock, vibration.

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Features

- 156.25MHz LVPECL
- Typical phase noise:
 - 104fs (Integration range: 1.875MHz-20MHz)
- ±20ppm total frequency stability
- -10°C to +75°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

Operating Ratings²

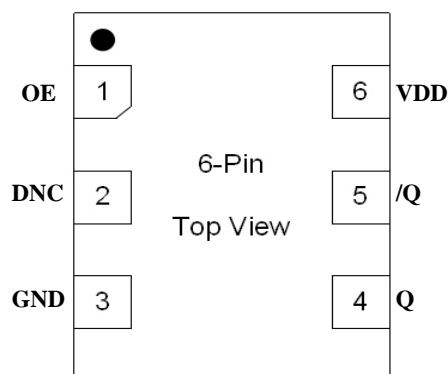
| | |
|---------------------------------------|-------------------|
| Supply Voltage (VIN)..... | +2.375V to +3.63V |
| Ambient Temperature (TA)..... | -10°C to +75°C |
| Junction Thermal Resistance | |
| LGA (T _{jc}) Still Air..... | 58°C/W |

Ordering Information

| Ordering Part Number | Marking Line 1 | Marking Line 3 | Shipping | Package |
|----------------------|----------------|----------------|---------------|-----------------------|
| MX553BHA156M250 | MX553B | HA1562 | Tube | 6-Pin 5mm x 3.2mm LGA |
| MX553BHA156M250-TR | MX553B | HA1562 | Tape and Reel | 6-Pin 5mm x 3.2mm LGA |

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

Pin Configuration



Pin Description

| Pin Number | Pin Name | Pin Type | Pin Level | Pin Function |
|------------|----------|----------|-----------|---|
| 1 | OE | I, SE | LVC MOS | Output Enable, disables output to tri-state, 0 = Disabled, 1 = Enabled, 50k Ω Pull-Up (Internal) |
| 2 | DNC | | | Make no connection, leave floating. |
| 3 | GND | PWR | | Power Supply Ground |
| 4, 5 | Q, /Q | O, Diff | LVPECL | Clock Output Frequency = 156.25MHz |
| 6 | VDD | PWR | | Power Supply |

Environmental Specifications

| | |
|------------------------------|--|
| Thermal Shock | MIL-STD-883, Method 1011, Condition A |
| Moisture Resistance | MIL-STD-883, Method 1004 |
| Mechanical Shock | MIL-STD-883, Method 2002, Condition C |
| Mechanical Vibration | MIL-STD-883, Method 2007, Condition B |
| Resistance to Soldering Heat | J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max) |
| Hazardous Substance | Pb-Free / RoHS / Green Compliant |
| Solderability | JESD22-B102-D Method 2 (Preconditioning E) |
| Terminal Strength | MIL-STD-883, Method 2004, Test Condition D |
| Gross Leak | MIL-STD-883, Method 1014, Condition C |
| Fine Leak | MIL-STD-883, Method 1014, Condition A2, R1=2x10 ⁻⁸ atm cc/s |
| MSL Level | Crystal - MSL-1, Package MSL-3 |
| Solvent Resistance | MIL-STD-202, Method 215 |

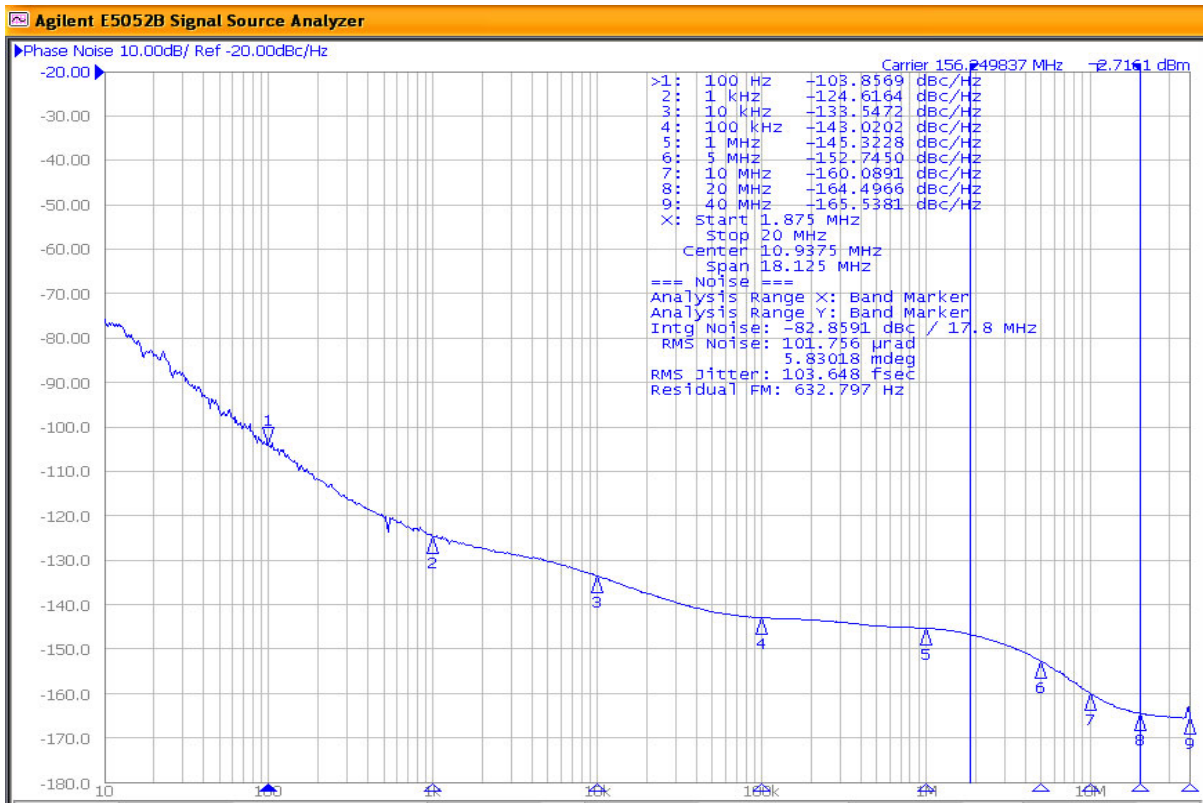


Figure 1. LVPECL Output 156.25MHz 1.875MHz-20MHz 104fs

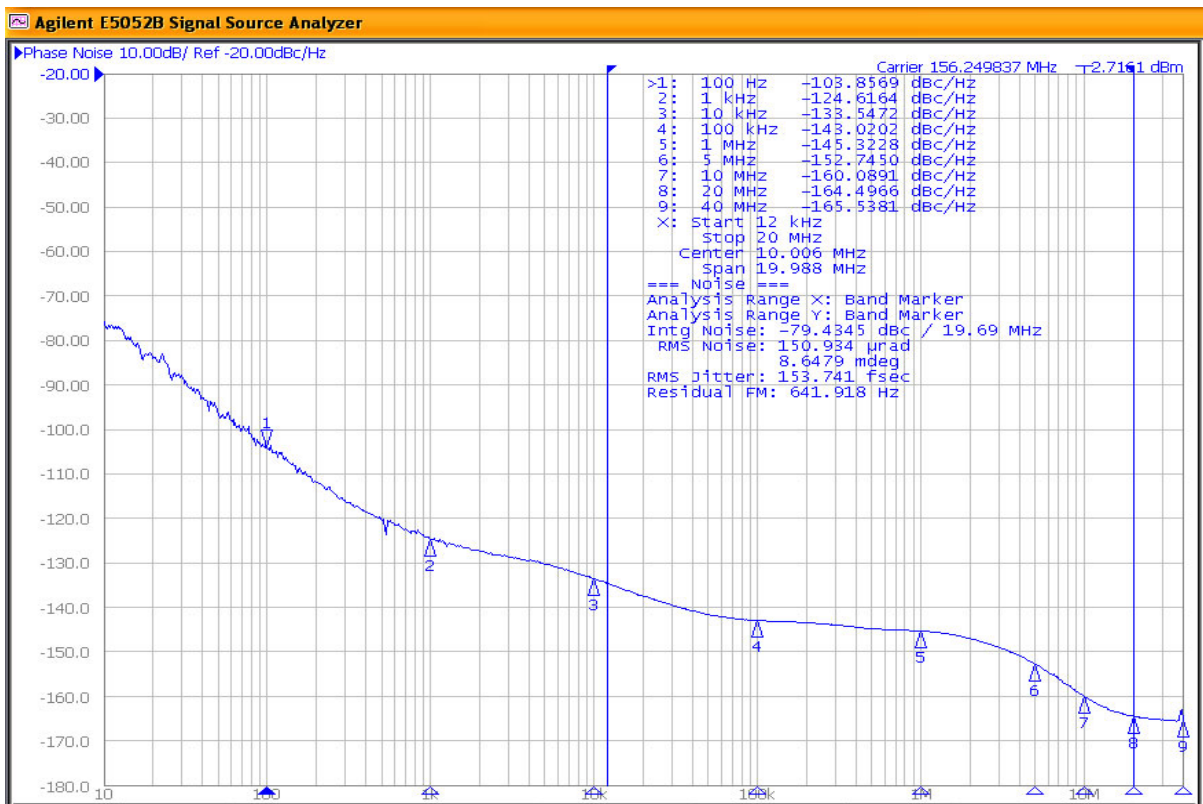
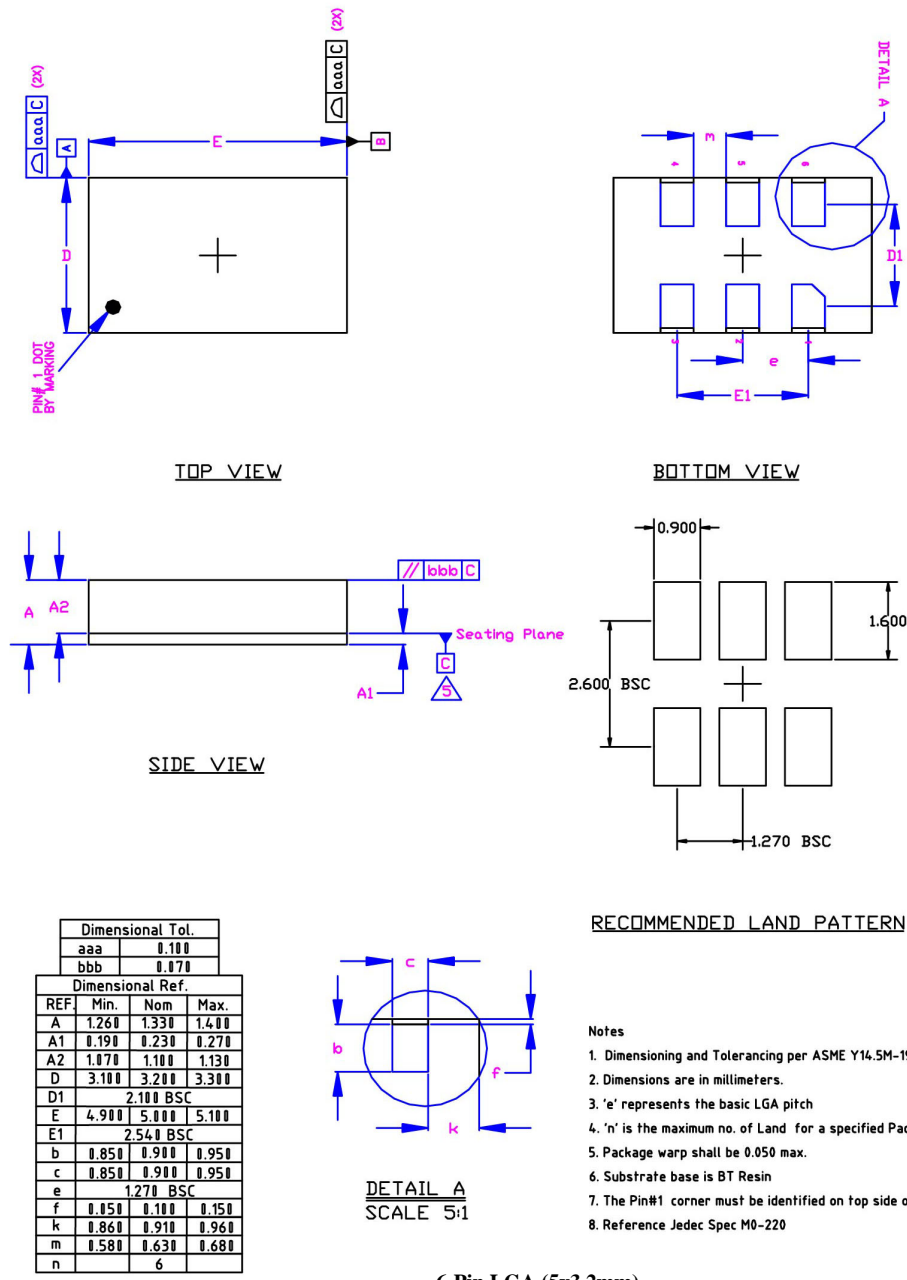


Figure 2. LVPECL Output 156.25MHz 12kHz-20MHz 154fs

Package Information and Recommended Land Pattern for 6-Pin LGA³



RECOMMENDED LAND PATTERN

- Notes**
1. Dimensioning and Tolerancing per ASME Y14.5M-1994.
 2. Dimensions are in millimeters.
 3. 'e' represents the basic LGA pitch
 4. 'n' is the maximum no. of Land for a specified Package.
 5. Package warp shall be 0.050 max.
 6. Substrate base is BT Resin
 7. The Pin#1 corner must be identified on top side only.
 8. Reference Jeduc Spec M0-220

Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

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